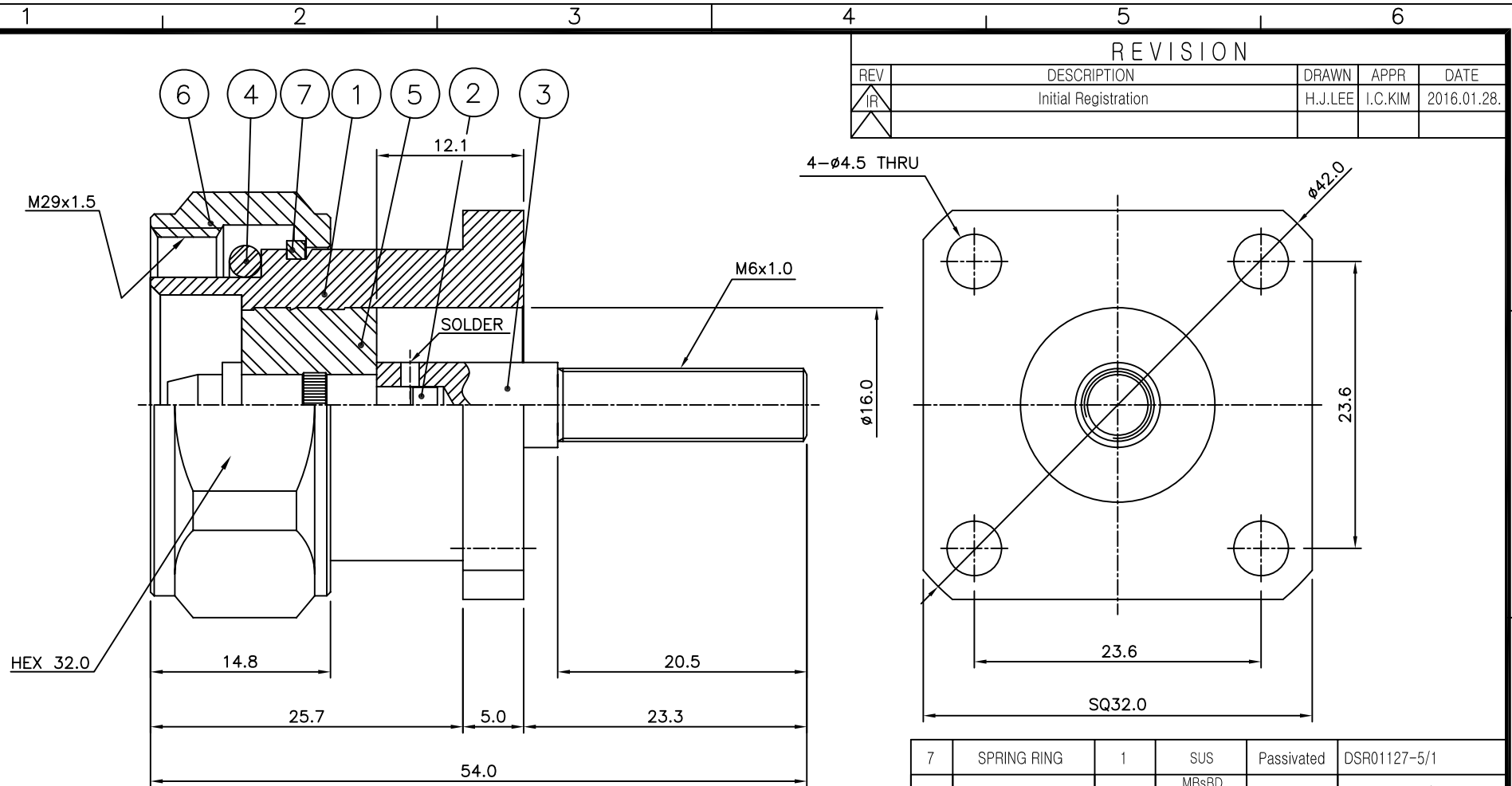




REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	H.J.LEE	I.C.KIM	2016.01.28.

* 조립방법

1. ②번 PIN에 ⑤번 TEFLON을 끼운다.
2. ⑤번 TEFLON을 조립한 PIN에 ③번 PIN을 억지끼움 한 후 납땜 작업으로 고정 시킨다.
3. PIN과 조립 된 TEFLON을 BODY에 조립한다.
4. 조립 된 BODY에 ⑥번 CAP, ⑦번 RING, ④번 GASKET 순서대로 조립한다.

7	SPRING RING	1	SUS	Passivated	DSR01127-5/1
6	COUPLING CAP	1	MBsBD C3604BD-F	Nickel Plate	DCU02260-5/3
5	INSULATOR	1	TEFLON		DIN02705-N/1
4	GASKET	1	SILICONE RUB		DGK00054-N/1
3	CONTACT	1	MBsBD C3604BD-F	Silver Plate	DCT03636-5/1
2	CONTACT	1	MBsBD C3604BD-F	Silver Plate	DCT03635-5/1
1	BODY	1	MBsBD C3604BD-F	Nickel Plate	DBD04094-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017			
	±0.1	2016. 01. 28.						
	Angle	APPROVED BY	I.C.KIM			KJ COMTECH CO.,LTD.		
	±1°	CHECKED BY						
MATERIAL	-	DRAWN BY	H.J.LEE			TITLE		
				7/16 DIN50 SOLDER END PS-4H				
FINISH	-	SCALE	UNIT		A4	DWG NO.	CN03535-7/2	
		2/1	mm			REVISION	IR	SHEET